



- MATERIALS**
1. HOUSING : LCP S475+30%GF (UL 94V-0) .
  2. TERMINAL : COPPER ALLOY C3191 EH,  
PLATING : GOLD PLATED 1u" ON CONTACT AREA  
AND SOLDER TAILS,NICKEL PLATED OVERALL 50u" .
  3. SHELL : STAINLESS STEEL SUS 201 H .  
PLATING : NICKEL PLATED OVERALL 50u" .  
GOLD PLATED 1u" ON SOLDER TAILS

- SPECIFICATION**
1. CURRENT RATING : 1.0 A MAX.
  2. DIELECTRIC WITHSTANDING VOLTAGE :  
500V AC R.M.S. FOR ONE MINUTE.
  3. INSULATION RESISTANCE : 1000MΩMIN. AT 500V DC.
  4. CONTACT RESISTANCE : 30mΩMAX.
  5. OPERATING TEMPERATURE : -40°C TO +85°C.

DESCRIPTION OF PLATING ON TERMINALS			
NO.	EXPLAIN	NO.	EXPLAIN
0	GOLD FLASH	3	GOLD 15u"
1	GOLD 5u"	4	GOLD 20u"
2	GOLD 10u"	6	GOLD 30u"

GENERAL TOLERANCE		DWG NO.	JYSA0525-009	APPD:	WIND	Scale	1:1
X.±0.45	X.±5'	Title	1.8H SIM CARD 6PIN 连接器 (勃渡PIN)	CHKD:		UNIT	mm
X±0.35	X.±2'	Part NO.	JYS-SIM180-103A	DR:		Date	2016/11/29
.XX±0.25	.XX.±1'						
.XXX±0.15	.xxx.±0.5'						
SHEET	1/1						



REV.	EQN.NO.	MODIFY CONTENT	DATE
A		NEW	2016/11/29